

## IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant:

Kie Y. Ahn et al.

Title:

SELECTIVE ELECTROLESS-PLATED COPPER METALLIZATION

Docket No .: Filed:

Examiner:

January 18, 2000

Due Date: N/A Group Art Unit: 1752

Serial No.: 09/483,881

Commissioner for Patents Washington, D.C. 20231

We are transmitting herewith the following attached items (as indicated with an "X"):

A return postcard. <u>X</u>

THO TO THE TOP THE TANK THE TA  $\overline{\mathbf{X}}$ A Supplemental Information Disclosure Statement (1 pgs.), Form 1449 (1 pgs.), and copies of 9 cited references.

Please consider this a PETITION FOR EXTENSION OF TIME for sufficient number of months to enter these papers and please charge any additional required fees or credit overpayment to Deposit Account No. 19-0743,

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CERTIFICATE UNDER 37 CFR 1.8: The undersigned hereby certifies that this correspondence is being deposited with the United States Postal Service with sufficient postage as first class mail, in an envelope addressed to: Commissioner for Patents, Washington, D.C. 20231, on this <u>30</u> day of <u>November</u>, 2001.

Gina M. Uphus

Name

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